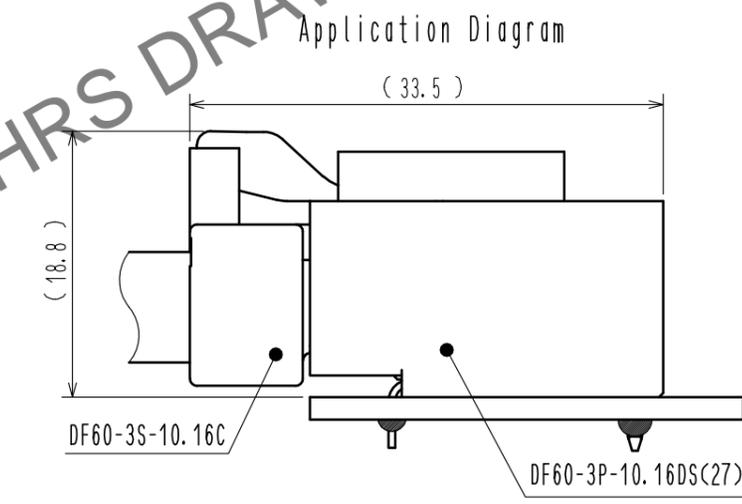
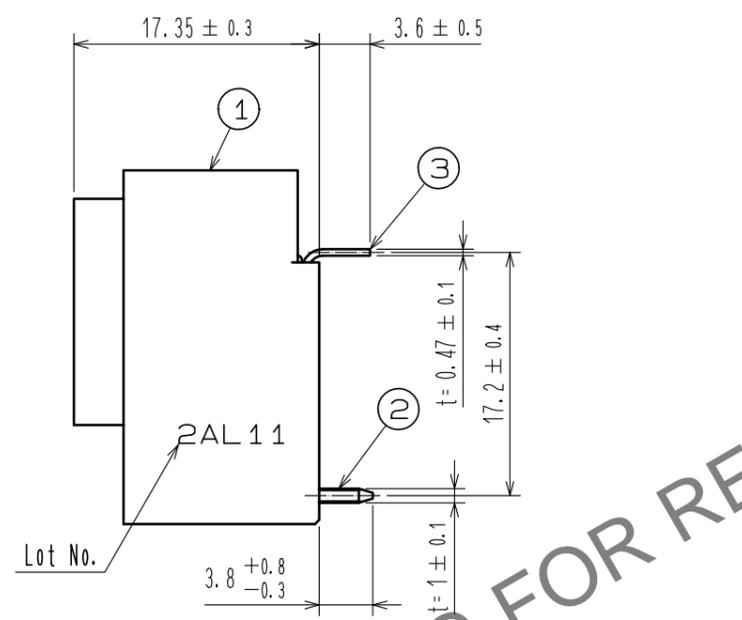
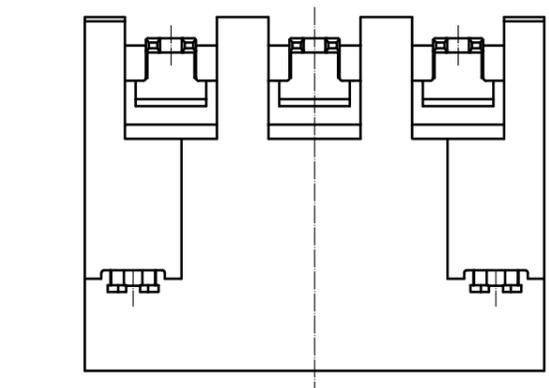
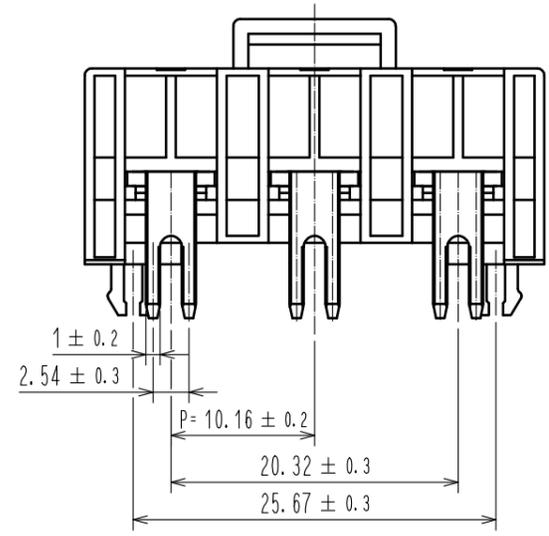
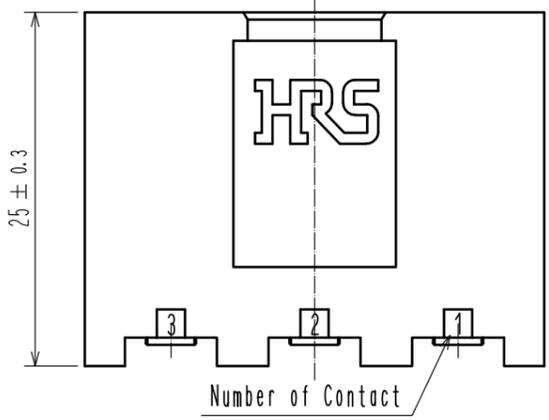
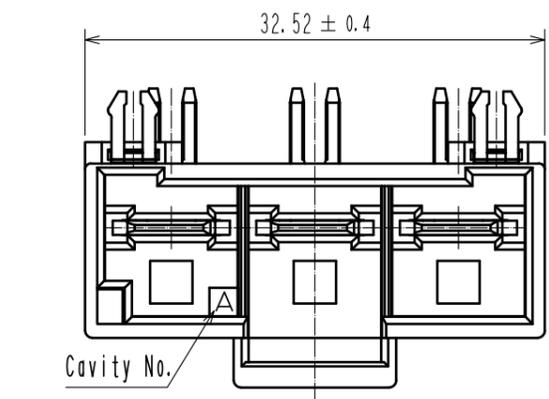
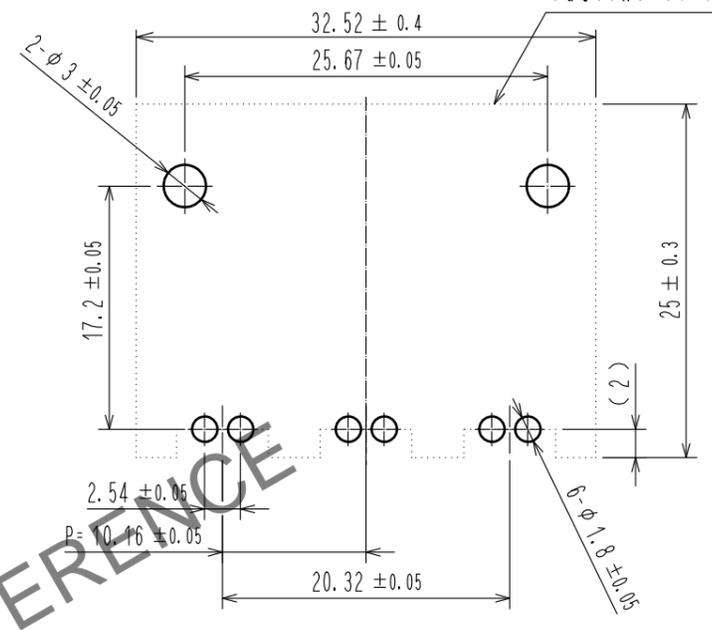


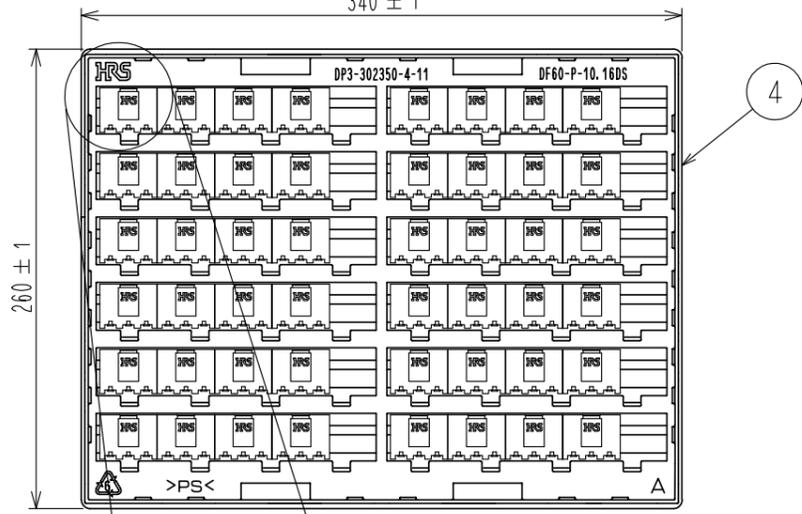
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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.



Recommended PCB Layout
(Board thickness : t=1.6±0.1mm)
Outline of Heder Housing



Packing Diagram(FREE)
340 ± 1



HRS DRAWING FOR REFERENCE

Notes 1. Per tray : 48 Pieces.
2. UL(File No. E52653)
C-UL(File No. E52653)
TUV (Certificate No. R50244085) authorization article.



4	PS	Clear
3	Brass	Tin Plating 1μm min
2	Copper Alloy	Contact Area : Au Plating 0.2μm min
		Lead area : Tin Plating 1μm min
		Under Plating : Ni Plating 1μm min

NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
1	PBT	BLACK. UL94-V0			

UNITS	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
mm				

APPROVED	: KI. AKIYAMA	16.04.05	DRAWING NO.	EDC-342145-27-00
CHECKED	: TS. FUKUSHIMA	16.04.05	PART NO.	DF60-3P-10.16DS(27)
DESIGNED	: TS. KUMAZAWA	16.04.05	CODE NO.	CL680-3017-7-27
DRAWN	: TS. KUMAZAWA	16.04.05		